



## Impact of the Kumamoto Earthquake



## Situation of the Kawashiri Factory After the Disaster

#### **Personnel**

- No human casualties
- Safety confirmation system
- Confirmed safety of all employees



#### **Building & Clean room**



- No large-scale damage
- Maintained CR power
- Reinforced facilities up to 6+ seismic intensity resistance level

## **Equipment & Components** (Jigs & Tools)

- Damage to the quartz jigs
- Switched to stockpiles
- Requested assistance





#### Renesas Electronics Group

Outsourced production

**Current Supply Chain Situation** 

Earthquake

Front-end

Earthquake

Back-end

Customers

Renesas Semiconductor Manufacturing Co., Ltd, Kawashiri Factory

Operation Resumed

Recovery\*1
Target Date

April 22

**May 22** 

Other Renesas Semiconductor Manufacturing Co., Ltd factories: Normal operation

Foundries: Normal operation

Subcontractors:

- Several subcontractors were affected by the quake
- ✓ Renesas has been supporting their recovery, targeting to reach full pre-earthquake capacity level at the earliest possible date

Renesas Semiconductor Package & Test Solutions Co., Ltd. : Normal operation 20%

Renesas Electronics Corporation:

Shipment

80%

Automotive, Industrial, Home Electronics, OA, ICT, Others

\*1: Recovery to full pre-earthquake capacity level (wafer input capacity)



Renesas

Design

-in

Develop

-ment

**Electronics** 

Corporation:

## Impact on Performance by Kumamoto Earthquake

#### **Impact on Net Sales**

- ✓ Impact from shutdown/low operation of production line (April June)
- ✓ Impact from shutdown/low operation of contractors' production lines

#### **Impact on Profits**

- ✓ Profit decrease from decrease in net sales (production)
- ✓ Recording of restoration-related expenses



The first products since the resumption of operations were shipped from the Kawashiri factory at 1:10 p.m. on April 23.



## **Looking Back on the Reform Plan**



## **Reform Plan Targets**

## Achieve gross margin of 45% and double-digit operating margin in FY2016

Execution
Phase
30 months
(Oct 2013
-March 2016)

Selection and Concentration

Manufacturing
Structural Reforms

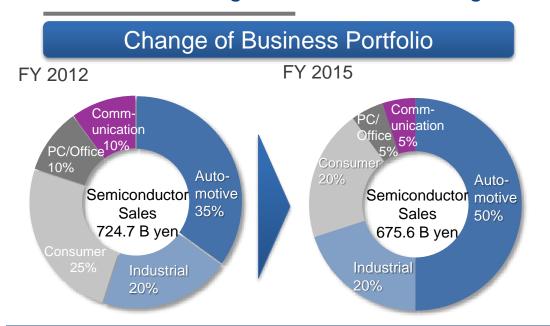
Structural Reforms of the Underlying Business- and Manufacturing Operations

Formulated in Oct 2013



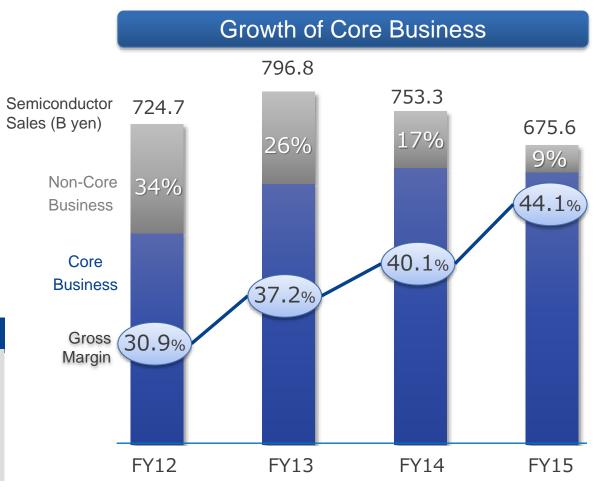
#### **Selection and Concentration**

Focus on advantageous businesses to significantly improve gross margin





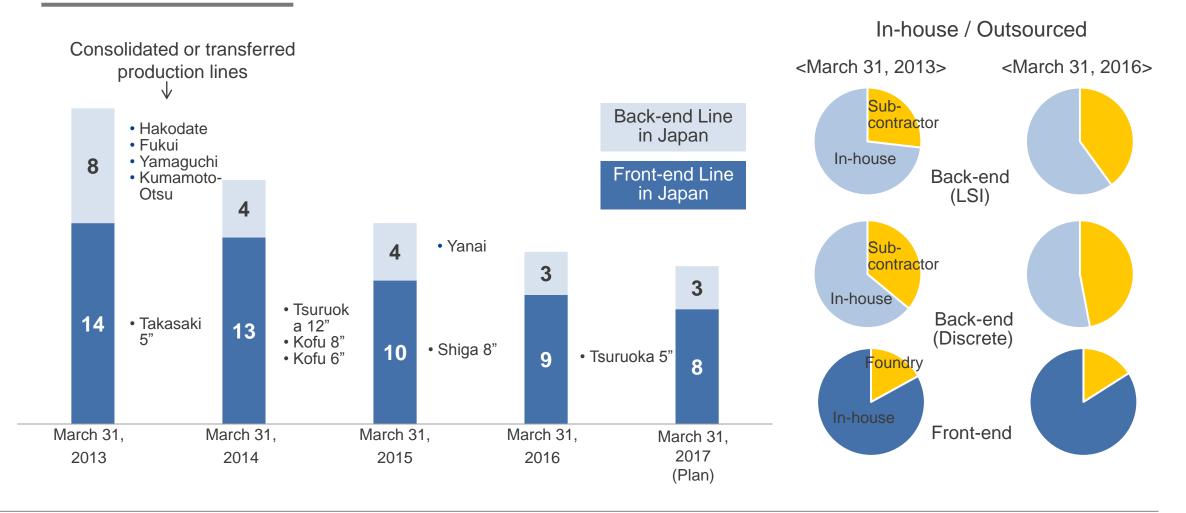
- Require continuous innovation
- High reliability and quality are essential
- √ Long product life cycle
- √ Low market volatility





## **Manufacturing Structural Reform**

Realigned manufacturing sites with selection and concentration of businesses

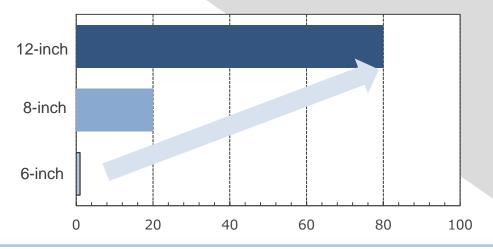


## **Towards an Optimal Manufacturing Structure**

Production data available from manufacturing equipment

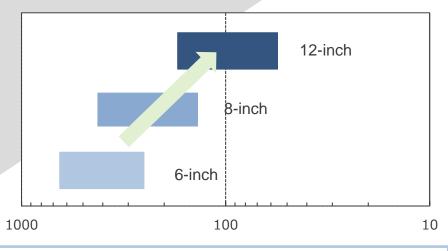
(1 data per Due 6-inch wafer)

✓ Efficient production system that realizes high quality and reliability requires massive data



Production technology (process node used by wafer)

✓ Higher functionality requires finer nodes



Minimum Line Width (nm)

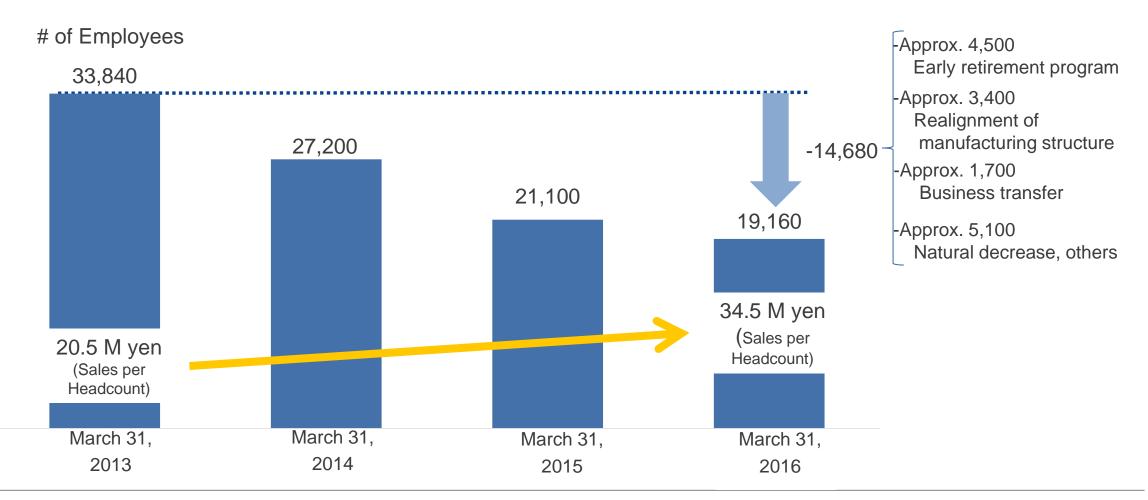
After recovery efforts from the 2016 Kumamoto Earthquake settles down, Renesas will investigate every possible alternative, including realignment, for the Group's 6-inch production lines with the goal of establishing a manufacturing structure optimized with Renesas' future business environment



#### Manufacturing Structural Reforms

## **Streamlining of Human Resources**

Streamlined headcounts in line with selection and concentration of businesses and manufacturing reforms



## **Operational Reforms**

Realized optimized management resources with via various measures

Realignment of manufacturing/
Design Sites

**New HR System** 

**Business Management** 

Global Management

## Realigned companies/sites by function to enhance operational efficiency

- Realigned manufacturing/design companies (April 2015)
- Realigned design sites (June 2015)
- Relocated headquarters to Toyosu (July 2015)

#### Introduced merit-based system to increase motivation

Introduced new HR (Human Resource) system (October 2014)

#### Established KPI according to function of each organization

- Set company-wide KPI (Key Performance Indicator) (April 2015)
- Evaluation of business/product development profitability and improved approval system (September 2014)

#### **Efforts to enhance global competitiveness**

- ➤ Adoption of global approval system (October 2014)
- Global HR system (began gradual introduction from September 2015 (on-going))



#### **Fixed Cost and Break Even Point**

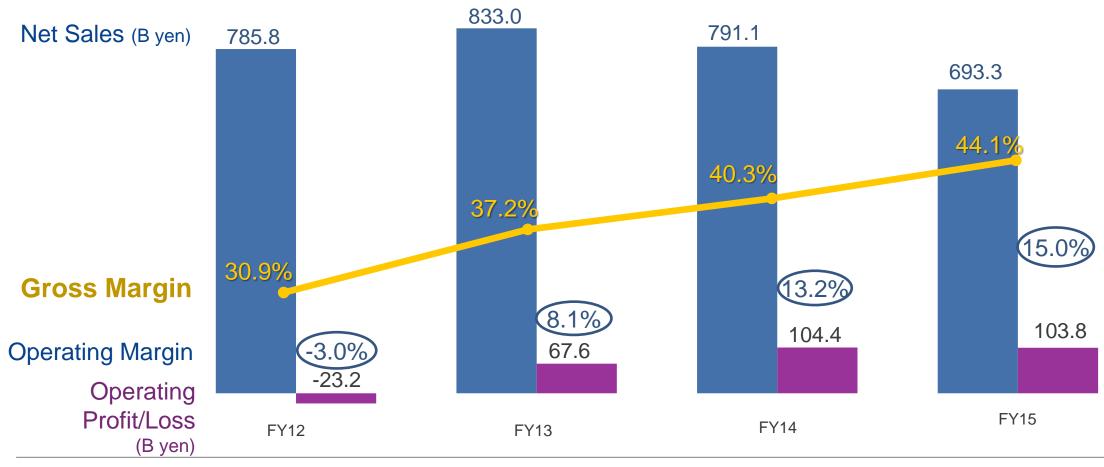
Became more resistant to the highly volatile semiconductor market





## Improved Profit through the Reform Plan

Improved gross margin and cost efficiency measures have expanded operating margin



## **Future Challenges**

Need to tackle emerging issues in addition to the remaining Reform Plan issues

# Optimization of Manufacturing Structure

Consider every means including realignment to establish a manufacturing structure optimized with Renesas' future business environment

#### **Low GP Products**

- Continue to withdraw from non-core products
- > Take measures against low GP products among core products

# Further Acceleration of Selection and Concentration

- Concentrate management resources on focus businesses
- > Select key base technologies and concentrate R&D resources on them



### **Summary**

- ✓ Based on the Reform Plan, Renesas promoted: (1) Selection and concentration of business; (2) Structural reforms concentrating on streamlining of production and human resources; and (3) Operational reforms
- Improved gross and operating margins by strengthening its capacity to address fluctuations of the highly volatile semiconductor market
- ✓ However, future challenges remain such as low-GP products among core products and optimization of the production structure
- ✓ While addressing these challenges, after effects of the earthquake clears, Renesas will
  again continue to target a 45% gross margin and a double-digit operating margin to prove
  that the Reform Plan was completed in the end of FY2015



#### (FOREWARD-LOOKING STATEMENTS)

The statements in this presentation with respect to the plans, strategies and forecasts of Renesas Electronics and its consolidated subsidiaries (collectively "we") are forward-looking statements involving risks and uncertainties. We caution you in advance that actual results could differ materially from such forward-looking statements due to several factors. The important factors that could cause actual results to differ materially from such statements include, but are not limited to: general economic conditions in our markets, which are primarily Japan, North America, Asia and Europe; demand for, and competitive pricing pressure on, our products and services in the marketplace; our ability to continue to win acceptance of its products and services in these highly competitive markets; and movements in currency exchange rates, particularly the rate between the yen and the U.S. dollar. Among other factors, a worsening of the world economy; a worsening of financial conditions in the world markets, and a deterioration in the domestic and overseas stock markets, would cause actual results to differ from the projected results forecast.

